

Lead free solder paste 500g, Sn96,5Ag3Cu0,5



- Solder paste NO-CLEAN
- Solder paste for stencil printing
- Grain size 4

[<https://www.tamura-elsold.de/index.php/en/downloads/safety-data-sheets-sds> Please download here the suitable safety data sheet]

item number	WL30138
model	Pastentyp AP-20
manufacturer	TAMURA ELSOLD
manufacturer item number	LOTPAST0004
order unit	1 cans
content unit	500 g

Products for the electronic industry



detail content unit	500 g
classification	DIN EN61190-1-1 RELO
alloy	Sn96,5Ag3Cu0,5
lead free/containing lead	lead free
metal content	88 %
metal powder size	20 – 38 µm